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With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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General Description

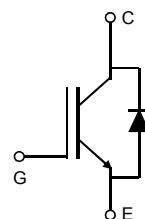
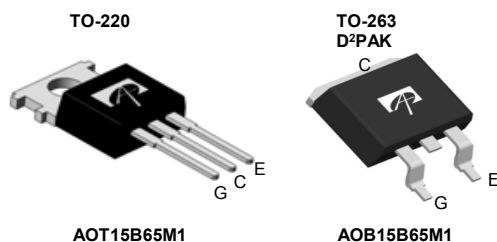
- Latest AlphaIGBT (α IGBT) technology
- 650V breakdown voltage
- Very fast and soft recovery freewheeling diode
- High efficient turn-on di/dt controllability
- Low VCE(SAT) enables high efficiencies
- Low turn-off switching loss and softness
- Very good EMI behavior
- High short-circuit ruggedness

Applications

- Motor Drives
- Sewing Machines
- Home Appliances
- Fan, Pumps, Vacuum Cleaner
- Other Hard Switching Applications

Product Summary

V_{CE}	650V
I_C ($T_C=100^\circ\text{C}$)	15A
$V_{CE(sat)}$ ($T_J=25^\circ\text{C}$)	1.7V



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOT15B65M1	TO220	Tube	1000
AOB15B65M1	TO263	Tape & Reel	800

Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOT15B65M1/AOB15B65M1	Units
Collector-Emitter Voltage	V_{CE}	650	V
Gate-Emitter Voltage	V_{GE}	± 30	V
Continuous Collector Current	I_C	$T_C=25^\circ\text{C}$	30
		$T_C=100^\circ\text{C}$	15
Pulsed Collector Current, Limited by T_{Jmax}	I_{CM}	45	A
Turn off SOA, $V_{CE} \leq 650\text{V}$, Limited by T_{Jmax}	I_{LM}	45	A
Continuous Diode Forward Current	I_F	$T_C=25^\circ\text{C}$	30
		$T_C=100^\circ\text{C}$	15
Diode Pulsed Current, Limited by T_{Jmax}	I_{FM}	45	A
Short circuit withstanding time ¹⁾ $V_{GE}=15\text{V}$, $V_{CC} \leq 400\text{V}$, $T_J \leq 175^\circ\text{C}$	t_{SC}	5	μs
Power Dissipation	P_D	$T_C=25^\circ\text{C}$	214
		$T_C=100^\circ\text{C}$	107
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	$^\circ\text{C}$
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	T_L	300	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	AOT15B65M1/AOB15B65M1	Units
Maximum Junction-to-Ambient	$R_{\theta JA}$	65	$^\circ\text{C/W}$
Maximum IGBT Junction-to-Case	$R_{\theta JC}$	0.7	$^\circ\text{C/W}$
Maximum Diode Junction-to-Case	$R_{\theta JC}$	1.9	$^\circ\text{C/W}$

1) Allowed number of short circuits: <1000; time between short circuits: >1s.

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
STATIC PARAMETERS							
BV_{CES}	Collector-Emitter Breakdown Voltage	$I_C=1mA, V_{GE}=0V, T_J=25^\circ C$	650	-	-	V	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=15A$	$T_J=25^\circ C$	-	1.7	2.15	V
			$T_J=125^\circ C$	-	2.03	-	
			$T_J=175^\circ C$	-	2.22	-	
V_F	Diode Forward Voltage	$V_{GE}=0V, I_C=15A$	$T_J=25^\circ C$	-	1.77	2.25	V
			$T_J=125^\circ C$	-	1.82	-	
			$T_J=175^\circ C$	-	1.75	-	
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$V_{CE}=5V, I_C=1mA$	-	5.1	-	V	
I_{CES}	Zero Gate Voltage Collector Current	$V_{CE}=650V, V_{GE}=0V$	$T_J=25^\circ C$	-	-	10	μA
			$T_J=125^\circ C$	-	-	500	
			$T_J=175^\circ C$	-	-	5000	
I_{GES}	Gate-Emitter leakage current	$V_{CE}=0V, V_{GE}=\pm 30V$	-	-	±100	nA	
g_{FS}	Forward Transconductance	$V_{CE}=20V, I_C=15A$	-	11	-	S	
DYNAMIC PARAMETERS							
C_{ies}	Input Capacitance	$V_{GE}=0V, V_{CC}=25V, f=1MHz$	-	923	-	pF	
C_{oes}	Output Capacitance		-	96	-	pF	
C_{res}	Reverse Transfer Capacitance		-	33	-	pF	
Q_g	Total Gate Charge	$V_{GE}=15V, V_{CC}=520V, I_C=15A$	-	32	-	nC	
Q_{ge}	Gate to Emitter Charge		-	7.8	-	nC	
Q_{gc}	Gate to Collector Charge		-	15	-	nC	
$I_{C(SC)}$	Short circuit collector current	$V_{GE}=15V, V_{CC}=400V,$ $t_{sc} \leq 5\mu s, T_J \leq 175^\circ C$	-	90	-	A	
R_g	Gate resistance	$V_{GE}=0V, V_{CC}=0V, f=1MHz$	-	6.7	-	Ω	
SWITCHING PARAMETERS, (Load Inductive, T_J=25°C)							
$t_{D(on)}$	Turn-On Delay Time	$T_J=25^\circ C$ $V_{GE}=15V, V_{CC}=400V, I_C=15A,$ $R_G=20\Omega$	-	15	-	ns	
t_r	Turn-On Rise Time		-	18	-	ns	
$t_{D(off)}$	Turn-Off Delay Time		-	94	-	ns	
t_f	Turn-Off Fall Time		-	14	-	ns	
E_{on}	Turn-On Energy		-	0.29	-	mJ	
E_{off}	Turn-Off Energy		-	0.2	-	mJ	
E_{total}	Total Switching Energy		-	0.49	-	mJ	
t_{rr}	Diode Reverse Recovery Time		$T_J=25^\circ C$	-	317	-	ns
Q_{rr}	Diode Reverse Recovery Charge		$I_F=15A, di/dt=200A/\mu s, V_{CC}=400V$	-	0.7	-	μC
I_{rm}	Diode Peak Reverse Recovery Current		-	4.7	-	A	
SWITCHING PARAMETERS, (Load Inductive, T_J=175°C)							
$t_{D(on)}$	Turn-On Delay Time	$T_J=175^\circ C$ $V_{GE}=15V, V_{CC}=400V, I_C=15A,$ $R_G=20\Omega$	-	13	-	ns	
t_r	Turn-On Rise Time		-	20	-	ns	
$t_{D(off)}$	Turn-Off Delay Time		-	116	-	ns	
t_f	Turn-Off Fall Time		-	28	-	ns	
E_{on}	Turn-On Energy		-	0.33	-	mJ	
E_{off}	Turn-Off Energy		-	0.36	-	mJ	
E_{total}	Total Switching Energy		-	0.69	-	mJ	
t_{rr}	Diode Reverse Recovery Time		$T_J=175^\circ C$	-	509	-	ns
Q_{rr}	Diode Reverse Recovery Charge		$I_F=15A, di/dt=200A/\mu s, V_{CC}=400V$	-	1.3	-	μC
I_{rm}	Diode Peak Reverse Recovery Current		-	6	-	A	

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

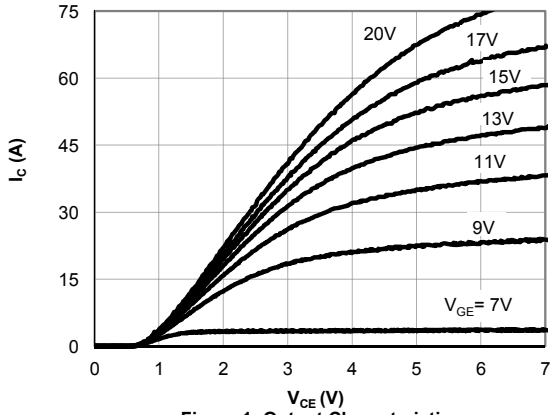


Figure 1: Output Characteristic
($T_j=25^\circ\text{C}$)

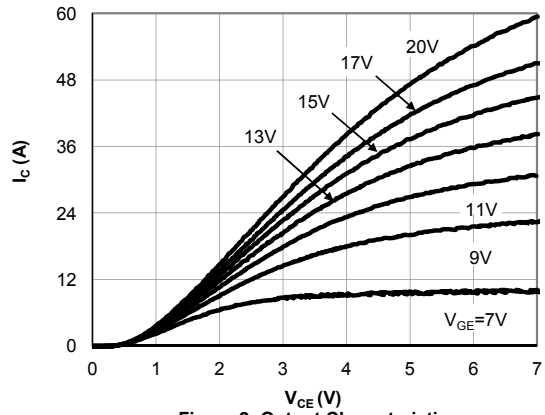


Figure 2: Output Characteristic
($T_j=175^\circ\text{C}$)

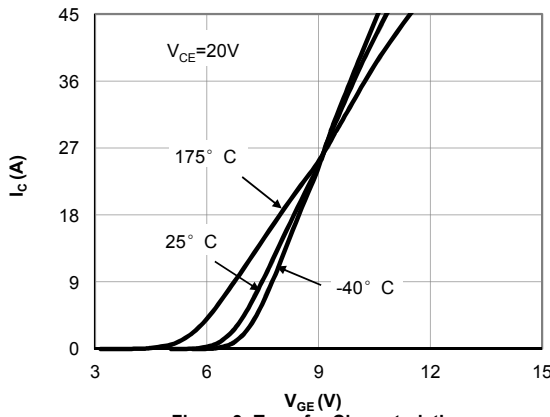


Figure 3: Transfer Characteristic

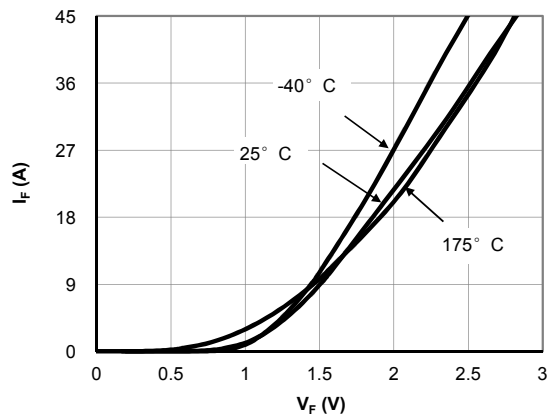


Figure 4: Diode Characteristic

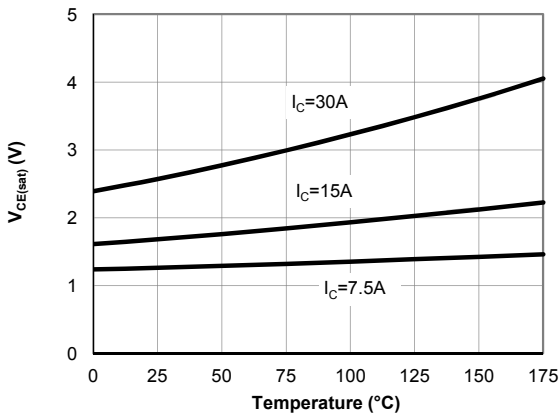


Figure 5: Collector-Emitter Saturation Voltage vs. Junction Temperature

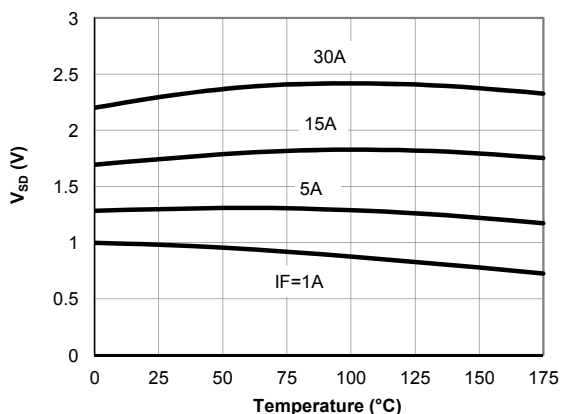


Figure 6: Diode Forward voltage vs. Junction Temperature

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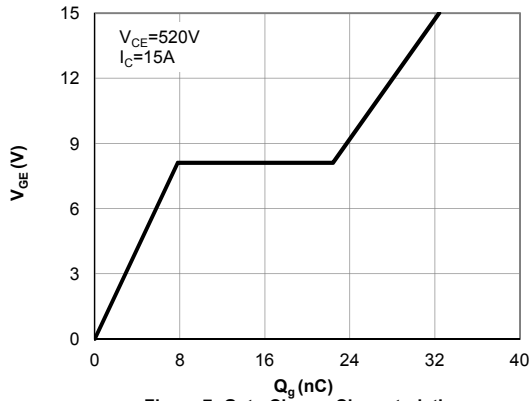


Figure 7: Gate-Charge Characteristics

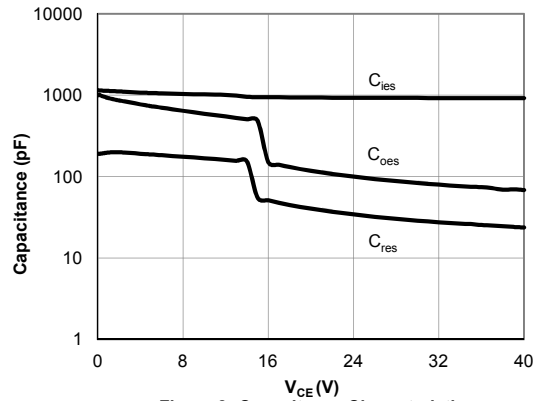


Figure 8: Capacitance Characteristic

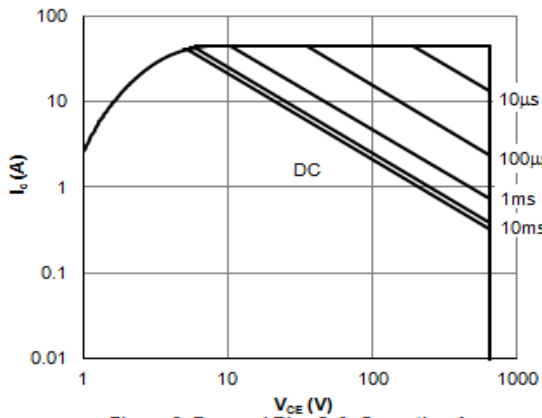


Figure 9: Forward Bias Safe Operating Area
($T_c=25^\circ\text{C}$, $V_{GE}=15\text{V}$)

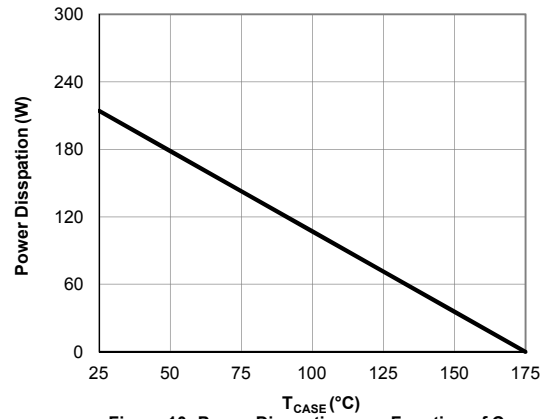


Figure 10: Power Dissipation as a Function of Case

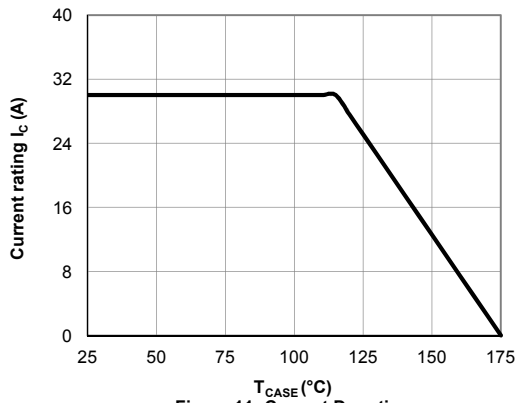


Figure 11: Current De-rating

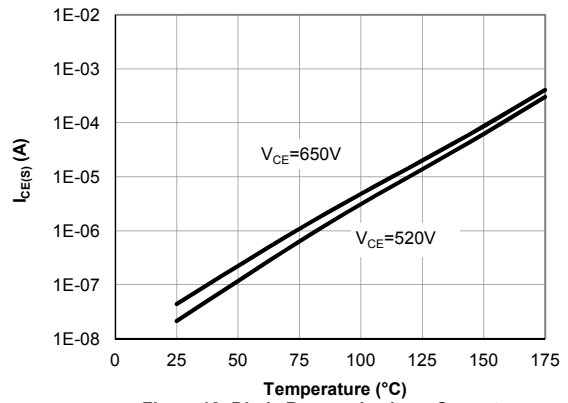


Figure 12: Diode Reverse Leakage Current vs. Junction Temperature

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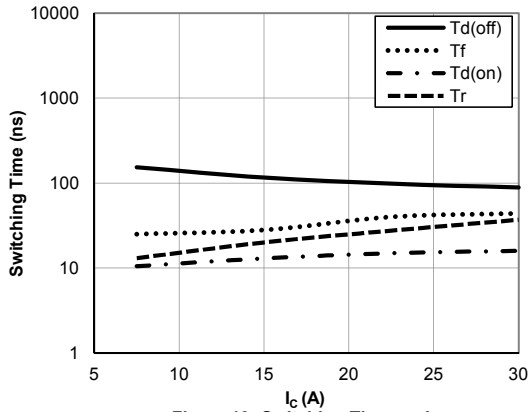


Figure 13: Switching Time vs. I_C
($T_J=175^\circ\text{C}$, $V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $R_g=20\Omega$)

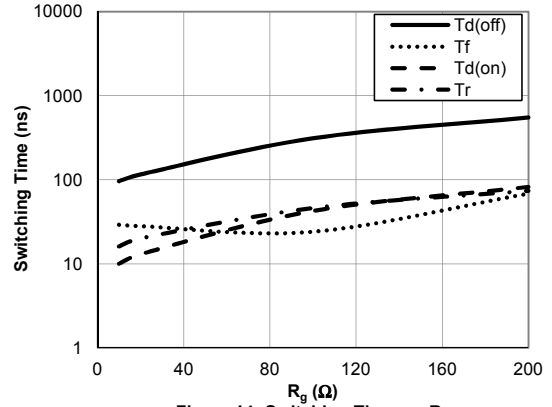


Figure 14: Switching Time vs. R_g
($T_J=175^\circ\text{C}$, $V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_C=15\text{A}$)

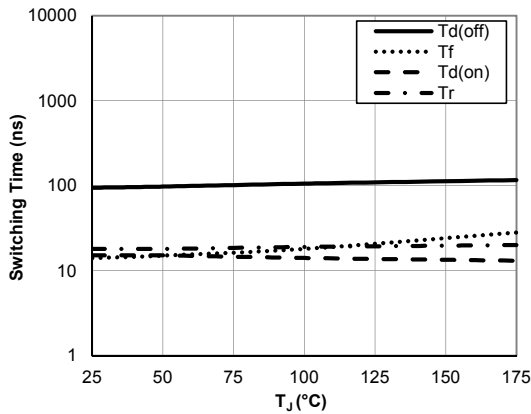


Figure 15: Switching Time vs. T_J
($V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_C=15\text{A}$, $R_g=20\Omega$)

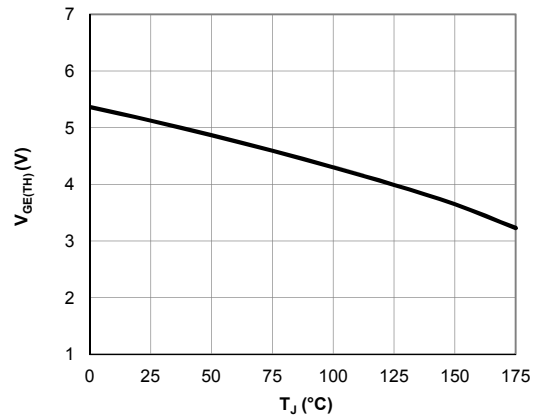


Figure 16: $V_{GE(TH)}$ vs. T_J

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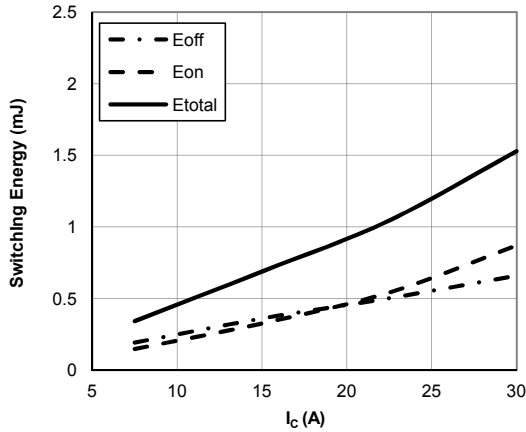


Figure 17: Switching Loss vs. I_c
($T_j=175^\circ\text{C}$, $V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $R_g=20\Omega$)

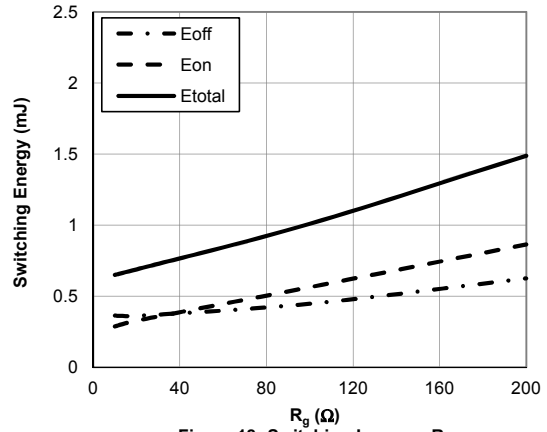


Figure 18: Switching Loss vs. R_g
($T_j=175^\circ\text{C}$, $V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_c=15\text{A}$)

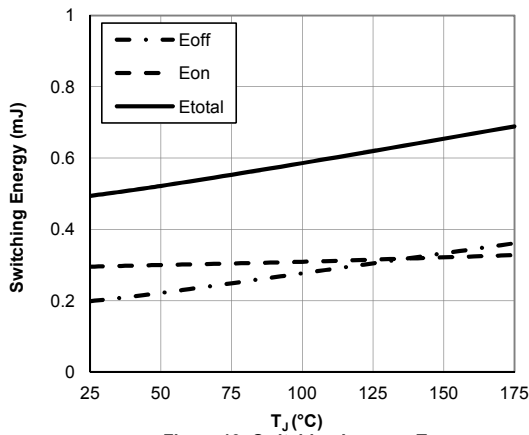


Figure 19: Switching Loss vs. T_j
($V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_c=15\text{A}$, $R_g=20\Omega$)

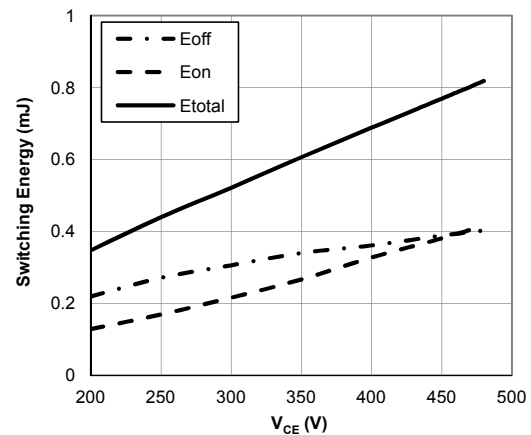


Figure 20: Switching Loss vs. V_{CE}
($T_j=175^\circ\text{C}$, $V_{GE}=15\text{V}$, $I_c=15\text{A}$, $R_g=20\Omega$)

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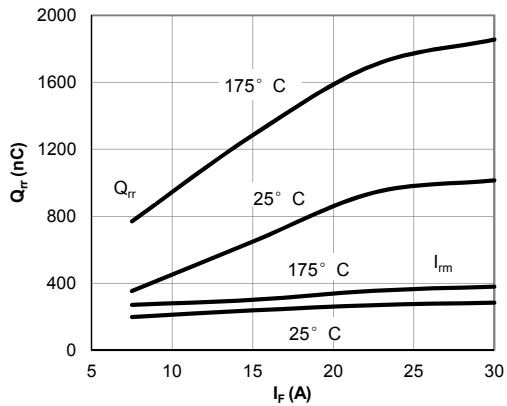


Figure 21: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current
($V_{GE}=15V, V_{CE}=400V, di/dt=200A/\mu s$)

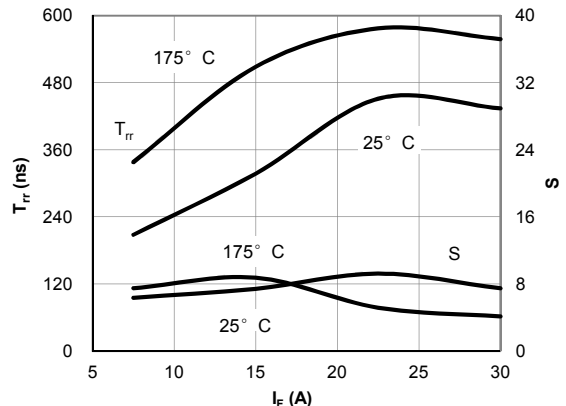


Figure 22: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current
($V_{GE}=15V, V_{CE}=400V, di/dt=200A/\mu s$)

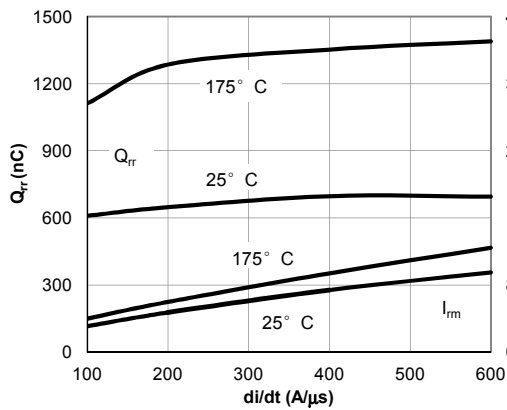


Figure 23: Diode Reverse Recovery Charge and Peak Current vs. di/dt
($V_{GE}=15V, V_{CE}=400V, I_F=15A$)

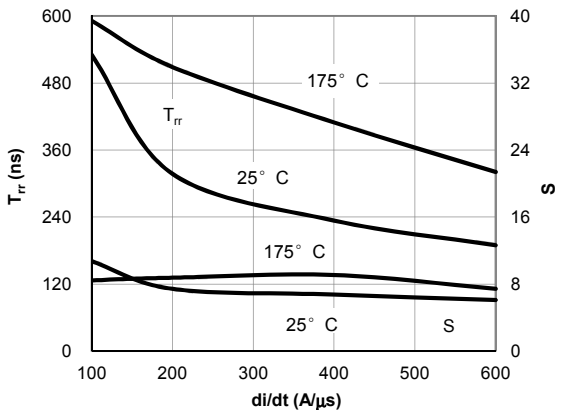


Figure 24: Diode Reverse Recovery Time and Softness Factor vs. di/dt
($V_{GE}=15V, V_{CE}=400V, I_F=15A$)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

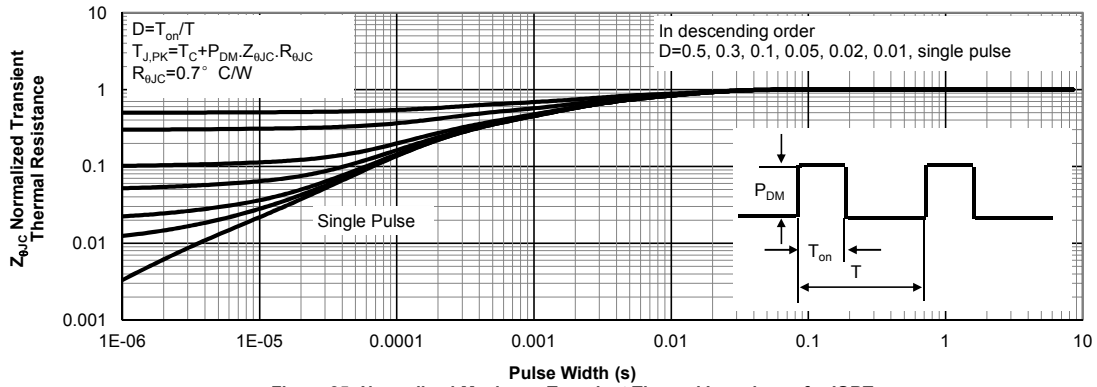


Figure 25: Normalized Maximum Transient Thermal Impedance for IGBT

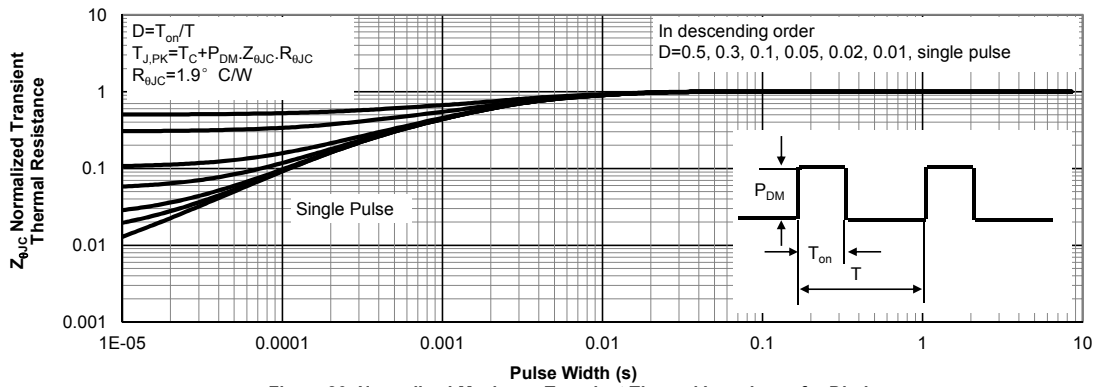


Figure 26: Normalized Maximum Transient Thermal Impedance for Diode

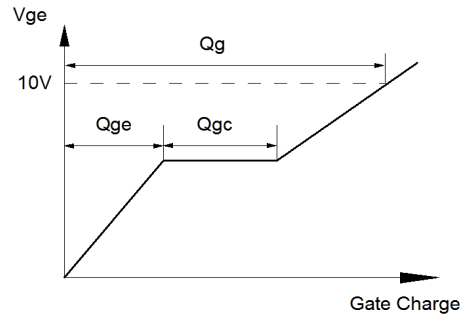
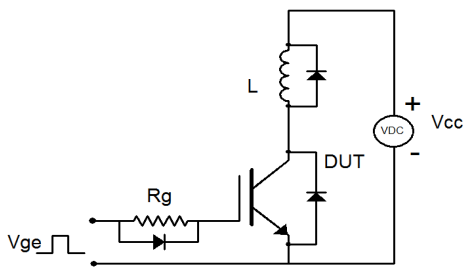


Figure A: Gate Charge Test Circuit & Waveforms

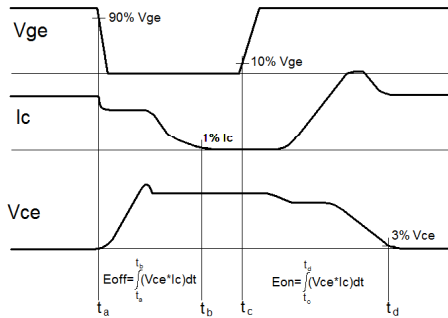
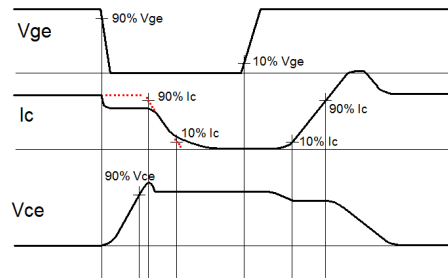
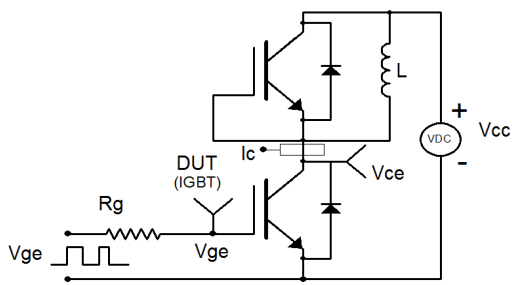


Figure B: Inductive Switching Test Circuit & Waveforms

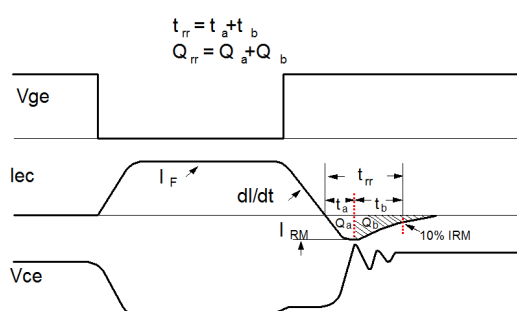
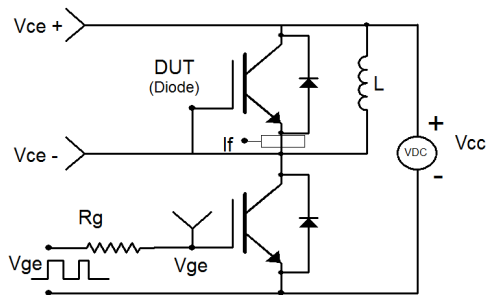


Figure C: Diode Recovery Test Circuit & Waveforms